# **KEMET Surface Mount RF Ceramic**

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## Characteristics and Typical Construction

- · Standard EIA Chip Sizes
- COG Dielectrics
- 6.3 250 Volts
- · Tape & Reel Packaging
- · Matte Tin finish terminations standard



### **RoHS Restricted Substance Content**

#### Key for Determining Adherence to China RoHS and 2011/65/EU Content Criteria<sup>1</sup>

0 = ≤ MCV, X = > MCV, X = > MCV, but EU RoHS Compliant with Exemption(s)

				Restricted Substance							
			Substance and MCV <sup>1</sup>	Cd	Cr <sup>6+</sup>	Pb	Hg	PBB	PBDE	Available	China RoHS
	KEMET Product	Series	Termination Code	< 0.01%	< 0.1%	< 0.1%	< 0.1%	< 0.1%	< 0.1%	since	Symbol <sup>3</sup>
Ī	Ceramic RF High Frequency	CBRXXC	С	0	0	0	0	0	0	Release	<b>(a)</b>

MCV = Maximum Concentration Values per 2011/65/EU and China RoHS criteria.

# **Soldering Capability Characteristics**

	Matte Tin Termination	SnPb Termination		
Termination Material	Silver or Copper	Silver or Copper		
Termination Plating (Barrier)	100% Matte Tin (Nickel)	90Sn10 Pb (Nickel)		
Peak Temperature Capability	260°C	260°C		
Soldering Process Compatibility	Backward & Forward Compatible	Backward & Forward Compatible		
MSL Rating per J-STD-020C	Not Classified <sup>4</sup>	Not Classified <sup>4</sup>		
Tin Whisker Test Results	Class 2	Class 2		
based on JESD22-A121 and JESD2015	CldSS 2			

MSL not classified for ceramic capacitors. 3-STD-020 is applicable to non-hermetic surface mount devices, and is intended for plastic package components. KEMET ceramic chips are not encapsulated in a plastic package, so they are not susceptible to these effects. If an MSL were required, the rating this product would be considered MSL 1 or better

# **Ordering**

CBR	02	С	330	F	9	G	A	C	TU
Series	Case Size (L*x W*)	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Voltage	Dielectric	Termination Style	Termination Finish	Packaging/Grade (C-Spec)
CBR	02 = 0201 04= 0402 06 = 0603 08 = 0805		2 Sig. Digits + Number of Zeros Use 9 for 1.0 - 9.9pF Use 8 for 0.5 - 99pF ex. 2.2pF = 229 ex. 0.5pF = 508	A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5%	9 = 6.3V 8 = 10V 3 = 25V 5 = 50V 1 = 100V A = 250V	G = C0G	A = N/A	C = 100% Matte Sn	TU = 7" Reel Unmarked

## **Identification**

Reel level **KEMET EZ ID** label indicates Product content relative to substance restrictions of the EU RoHS Directive, 2011/65/EU and China RoHS. RoHS-PRC = Meets criteria without exemption RoHS-EU = Meets criteria with exemption RoHS-NO = Does not meet criteria





China RoHS Symbol based on current manufacturing. Refer to notes in Pb column for transition dates.

<sup>&</sup>lt;sup>5</sup> Per EIA/ECA component bulletin CB19, tin whiskering is not considered a reliability risk within the capacitor industry for non-Military / Hi-Rel applications.